

Package impedance and termination effect on COM (update based on D3.3 and revised COM code)

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802.3bs Interim meeting Sept 2017.

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Introduction



- This is an update to work presented in dudek_3bs_02_0517 and dudek_3bs_01_0717. Significant changes were made to the specification in 802.3bs Draft 3.3 and this presentation shows the result. It is a supporting presentation for comment r03-20.
- It is an update to the presentation made in the electrical ad-hoc on 8/28/17 using revised COM code that corrected an issue when Rd for the Tx and Rx are different.
- The presentation explores the impact of varying package impedance (Zc) and R_d termination on for the 400GAUI-8 (Clause 120D) chip to chip specification.
- COM uses a particular package trace impedance and die impedance for its calculations, and it has been shown in these previous presentations and by Yasuo Hidaka in 802.3cd (e.g. hidaka_3cd_01a_0317) that there is no one combination that gives worse case results for all channels.

Key changes in Draft 3.3



- A tight return loss specification was added to the interference tolerance test system.
 - This is expected to reduce variability in the interference tolerance test and also will mean that Receivers that have poorer return loss will need to have better other performance to compensate. For this reason for this presentation only the Tx die and package impedance were changed.
- A return loss specification was added to the channel for marginal channels (COM <4.0dB). The channel with the worst variability in the previous work (Mellitz_3bs_04_0714) fails this specification, and therefore does not need to be considered.
- The die impedance and package trace impedance were changed to nominal values of 50 Ohm and 95 Ohm respectively with changes to Av, Afe, and Ane to keep the steady state voltage at 0.4V.

Methodology



- Four variations of Tx package and die impedances are evaluated to cover manufacturing tolerances and potential different target impedance values. In addition another package option based on Mellitz_3bs_01a_0717 was included. (Relative to the Mellitz_3bs_01a0717 package it had somewhat lower capacitance in order to meet the Tx return loss specification.)
- All COM parameters, other than those shown in tables, are the same as in IEEE P802.3bs/D3.3 spec. The Rx package and die impedances were kept at the values in the D3.3 spec.
- Av was adjusted so that the steady state voltage Vf is kept equal to 0.4V for all the combinations.
- The first eight channels evaluated are found at http://grouper.ieee.org/groups/802/3/bs/public/channel/index.shtml. The additional two channels have smaller capacitive discontinuities and higher impedance (but not higher than 110 ohms). Three additional channels provided to 802.3cd by Cisco were included in this analysis. http://grouper.ieee.org/groups/802/3/cd/public/channel/index.html

Effect of Changing Tx package and die impedance – COM Code - com_ieee8023_93a_200b.m



	·										
	D3.3	D3.2	CAVM mod1	CAVM mod2	CAVM mod5	CAVM mod6 (similar to Mellitz_3bs_0 1a_0717)	Delta D3.2 to D3.3	Delta mod1 to D3.3	Delta mod2 to D3.3	Delta mod5 to D3.3	Delta mod6 to D3.3
package_Zc (ohms) [Tx Rx]	[95 95]	[90 90]	[100 95]	[110 95]	[85 95]	[110 95]					
Av/Afe (V)	0.418	0.44	0.418	0.394	0.45	0.394					
Ane (V)	0.604	0.63	0.604	0.604	0.604	0.604					
Cd (nF)	1.80E-04	1.80E-04	1.80E-04	1.80E-04	1.80E-04	1.00E-04		Largest ne	gative diff	erence	
Cp(nF)	[1.1 1.1]E-4	[1.8 1.1]E-4		Largest po	sitive diffe	erence					
Rd (ohms) [Tx Rx]	[50 50]	[55 55]	[50 50]	[45 50]	[55 50]	[45 50]					
Channels	nels										
mellitz_3bs_02_0714	3.67	3.68	3.68	3.68	3.66	3.82	0.01	0.01	0.01	-0.01	0.15
mellitz_3bs_03_0714	4.35	4.1	4.3	4.25	4.22	4.35	-0.25	-0.05	-0.1	-0.13	C
mellitz_3bs_04_0714	4.54	4.42	4.46	4.39	4.44	4.54	-0.12	-0.08	-0.15	-0.1	C
mellitz_3bs_05_0714	3.42	3.29	3.42	3.41	3.4	3.51	-0.13	0	-0.01	-0.02	0.09
mellitz_3bs_06_0714	2.75	2.73	2.71	2.73	2.73	2.92	-0.02	-0.04	-0.02	-0.02	0.17
mellitz_3bs_07_0714	4.28	4.16	4.23	4.13	4.18	4.28	-0.12	-0.05	-0.15	-0.1	C
mellitz_3bs_08_0714	4.2	4.09	4.13	4.04	4.13	4.22	-0.11	-0.07	-0.16	-0.07	0.02
shanbhag_01_0914	5.08	4.91	5.02	4.94	4.94	5.09	-0.17	-0.06	-0.14	-0.14	0.01
Cavium_20dB_HghZ /w reduced xtlk	3.17	2.66	3.24	3.13	2.85	3.17	-0.51	0.07	-0.04	-0.32	C
Cavium_20dB_HghZ_Nom_HighZ /w reduced xtlk	3.36	2.91	3.42	3.32	3.03	3.31	-0.45	0.06	-0.04	-0.33	-0.05
Cisco CH1	3.72	3.08	3.77	3.76	3.17	3.97	-0.64	0.05	0.04	-0.55	0.25
Cisco CH3	3.15	2.53	3.22	3.26	2.63	3.48	-0.62	0.07	0.11	-0.52	0.33
Cisco CH4	2.67	2.21	2.69	2.53	2.3	2.67	-0.46	0.02	-0.14	-0.37	0

Conclusions



- The changes made to the specification in D3.3 have significantly improved the situation.
- The changes to the COM parameters going from D3.2 to D3.3 have improved the results by over 0.2dB for many channels.
- There is still about 0.2dB hole in the specification (more for some channels).
 i.e. The performance of a compliant Tx plus channel can be greater than 0.2dB worse COM than that calculated in the Channel COM test.
- The COM requirement for the channel should be changed to 3.2dB while leaving the COM for the Interference tolerance test at 3.0dB.



Backup

Effect of Changing Tx package and die impedance – COM Code - com_ieee8023_93a_173.m



Slide from Dudek_3bs_electrical ad hoc August 28

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			CHANNE	LS AS IS							
	D3.3	D3.2	CAVM mod1	CAVM mod2	CAVM mod5	CAVM mod6 (similar to Mellitz_3bs_0 1a_0717)	Delta D3.2 to D3.3	Delta mod1 to D3.3	Delta mod2 to D3.3	Delta mod5 to D3.3	Delta mod6 to D3.3
package_Zc (ohms) [Tx Rx]	[95 95]	[90 90]	[100 95]	[110 95]	[85 95]	[110 95]				•	
Av/Afe (V)	0.418	0.44	0.418	0.394	0.45	0.394					
Ane (V)	0.604	0.63	0.604	0.604	0.604	0.604					
Cd (nF)	1.80E-04	1.80E-04	1.80E-04	1.80E-04	1.80E-04	1.00E-04		Largest ne	gative diff	erence	
Cp(nF)	[1.1 1.1]E-4	[1.8 1.1]E-4		Largest po	sitive diffe	erence					
Rd (ohms) [Tx Rx]	[50 50]	[55 55]	[50 50]	[45 50]	[55 50]	[45 50]					
Channels											
mellitz_3bs_02_0714	3.67	3.68	3.68	3.55	3.74	3.63	0.01	0.01	-0.12	0.07	-0.04
mellitz_3bs_03_0714	4.35	4.1	4.3	4.1	4.23	4.27	-0.25	-0.05	-0.25	-0.12	-0.08
mellitz_3bs_04_0714	4.54	4.42	4.46	4.33	4.46	4.56	-0.12	-0.08	-0.21	-0.08	0.02
mellitz_3bs_05_0714	3.42	3.29	3.42	3.14	3.45	3.31	-0.13	0	-0.28	0.03	-0.11
mellitz_3bs_06_0714	2.75	2.73	2.71	2.64	2.85	2.88	-0.02	-0.04	-0.11	0.1	0.13
mellitz_3bs_07_0714	4.28	4.16	4.23	4.04	4.24	4.32	-0.12	-0.05	-0.24	-0.04	0.04
mellitz_3bs_08_0714	4.2	4.09	4.13	3.98	4.14	4.22	-0.11	-0.07	-0.22	-0.06	0.02
shanbhag_01_0914	5.08	4.91	5.02	4.77	5.05	4.95	-0.17	-0.06	-0.31	-0.03	-0.13
Cavium_20dB_HghZ /w reduced xtlk	3.17	2.66	3.24	3.08	2.95	3.18	-0.51	0.07	-0.09	-0.22	0.01
Cavium_20dB_HghZ_Nom_HighZ /w reduced xtlk		2.91	3.42	3.22	3.15	3.29	-0.45	0.06	-0.14	-0.21	-0.07
Cisco CH1	3.72	3.08	3.77	3.67	3.27	3.91	-0.64	0.05	-0.05	-0.45	0.19
Cisco CH3		2.53	3.22	3.12	2.77	3.38	-0.62	0.07	-0.03	-0.38	0.23
Cisco CH4	2.67	2.21	2.69	2.44	2.45	2.6	-0.46	0.02	-0.23	-0.22	-0.07

Effect of Changing Tx package and die impedance – CHANNELS REVERSED COM Code - com_ieee8023_93a_173.m



Slide from Dudek_3bs_electrical ad hoc August 28

	Onde	, nem Baa	CK_ODO_CI		noo / tage						
			CHANNELS	REVERSED							
						CAVM mod6	Delta	Delta	Delta	Delta	Delta
	D3.3	D3.2	CAVM mod1	CAVM mod2	CAVM	(similar to	D3.2	mod1	mod2	mod5	mod6
	2010	55.2			mod5	Mellitz_3bs_0	to	to	to	to	to
			[100 95] [110 0.418 0.3 0.604 0.0 1.80E-04 1.80 [1.1 1.1]E-4 [1.1 1 [50 50] [45 3.67 3. 4.28 4. 4.41 4. 3.38 3. 2.65 2.			1a_0717)	D3.3	D3.3	D3.3	D3.3	D3.3
package_Zc (ohms) [Tx Rx]	[95 95]	[90 90]	[100 95]	[110 95]	[85 95]	[110 95]					
Av/Afe (V)	0.418	0.44	0.418	0.394	0.45	0.394					
Ane (V)	0.604	0.63	0.604	0.604	0.604	0.604					
Cd (nF)	1.80E-04	1.80E-04	1.80E-04	1.80E-04	1.80E-04	1.00E-04		Largest ne	gative diff	erence	
Cp(nF)	[1.1 1.1]E-4	[1.1 1.1]E-4	[1.1 1.1]E-4	[1.1 1.1]E-4	[1.1 1.1]E-4	[1.8 1.1]E-4		Largest po	sitive diffe	erence	
Rd (ohms) [Tx Rx]	[50 50]	[55 55]	[50 50]	[45 50]	[55 50]	[45 50]					
Channels											
mellitz_3bs_02_0714	3.67	3.68	3.67	3.51	3.69	3.67	0.01	0	-0.16	0.02	0
mellitz_3bs_03_0714	4.35	4.12	4.28	4.11	4.18	4.04	-0.23	-0.07	-0.24	-0.17	-0.31
mellitz_3bs_04_0714	4.54	4.42	4.41	4.17	4.51	4.21	-0.12	-0.13	-0.37	-0.03	-0.33
mellitz_3bs_05_0714	3.42	3.29	3.38	3.24	3.44	3.21	-0.13	-0.04	-0.18	0.02	-0.21
mellitz_3bs_06_0714	2.75	2.73	2.65	2.59	2.89	2.8	-0.02	-0.1	-0.16	0.14	0.05
mellitz_3bs_07_0714	4.28	4.16	4.19	3.92	4.22	4.2	-0.12	-0.09	-0.36	-0.06	-0.08
mellitz_3bs_08_0714	4.2	4.09	4.08	3.83	4.18	3.96	-0.11	-0.12	-0.37	-0.02	-0.24
shanbhag_01_0914	5.08	4.91	5.02	4.76	5.06	4.94	-0.17	-0.06	-0.32	-0.02	-0.14
Cavium_20dB_HghZ /w reduced xtlk	3.21	2.66	3.28	3.08	2.94	3.17	-0.55	0.07	-0.13	-0.27	-0.04
Cavium_20dB_HghZ_Nom_HighZ /w reduced xtlk	3.38	2.92	3.42	3.26	3.17	3.32	-0.46	0.04	-0.12	-0.21	-0.06
Cisco CH1	3.71	3.08	3.76	3.76	3.24	3.98	-0.63	0.05	0.05	-0.47	0.27
Cisco CH3	3.16	2.51	3.21	3.21	2.74	3.49	-0.65	0.05	0.05	-0.42	0.33
Cisco CH4	2.67	2.2	2.7	2.53	2.38	2.84	-0.47	0.03	-0.14	-0.29	0.17

Effect of lower package impedance (Mod 4) that fails Tx SNR_{ISI}



Slide from Dudek_3bs_01_0717

	D3.1 ORGINAL	D3.1 CAVM mod1	D3.1 CAVM mod2	D3.1 CAVM mod3	D3.1 CAVM mod4	Delta mod1 to original	Delta mod2 to original	Delta mod3 to original	Delta mod4 to original
package_Zc (ohms)	90	100	110	95	80				
Av/Afe (V)	0.45	0.418	0.394	0.416	0.441				
Cd (nF)	1.80E-04	1.80E-04	1.80E-04	1.80E-04	1.80E-04		Largest ne	gative diffe	erence
Rd (ohms)	[55 55]	[50 50]	[45 45]	[50 50]	[55 55]		Largest po	sitive diffe	rence
Channels									
mellitz_3bs_02_0714	3.54	3.51	3.27	3.6	2.63	-0.03	-0.27	0.06	-0.91
mellitz_3bs_03_0714	4.02	4.17	3.81	4.2	3.1	0.15	-0.21	0.18	-0.92
mellitz_3bs_04_0714	4.39	4.08	3.53	4.24	3.53	-0.31	-0.86	-0.15	-0.86
mellitz_3bs_05_0714	3.13	3.35	2.96	3.19	2.43	0.22	-0.17	0.06	-0.7
mellitz_3bs_06_0714	2.7	2.65	2.47	2.71	2.25	-0.05	-0.23	0.01	-0.45
mellitz_3bs_07_0714	4.11	4.07	3.68	4.21	3.31	-0.04	-0.43	0.1	-0.8
mellitz_3bs_08_0714	4.02	3.92	3.52	4.13	3.29	-0.1	-0.5	0.11	-0.73
shanbhag_01_0914	4.93	4.98	4.61	5.08	4	0.05	-0.32	0.15	-0.93
Cavium_20dB_HghZ /w reduced xtlk	2.7	3.28	2.92	3.17	1.57	0.58	0.22	0.47	-1.13
Cavium_20dB_HghZ_Nom_HighZ /w reduced xtlk	2.96	3.46	3.11	3.36	1.94	0.5	0.15	0.4	-1.02

COM comparison to Mod3 (OIF adopted) - Mod4 added



Slide from Dudek 3bs 01 0717

	D3.1 ORGINAL	D3.1 CAVM	D3.1 CAVM	D3.1 CAVM	D3.1 CAVM	Delta original	Delta mod1	Delta mod2	Delta mod4
		mod1	mod2	mod3	mod4	to	to	to	to
						mod3	mod3	mod3	mod3
package_Zc (ohms)	90	100	110	95	80				
Av/Afe (V)	0.45	0.418	0.394	0.416	0.441				
Cd (nF)	1.80E-04	1.80E-04	1.80E-04	1.80E-04	1.80E-04		Largest ne	gative diffe	rence
Rd (ohms)	[55 55]	[50 50]	[45 45]	[50 50]	[55 55]		Largest po	sitive differ	rence
Channels									
mellitz_3bs_02_0714	3.54	3.51	3.27	3.6	2.63	-0.06	-0.09	-0.33	-0.97
mellitz_3bs_03_0714	4.02	4.17	3.81	4.2	3.1	-0.18	-0.03	-0.39	-1.1
mellitz_3bs_04_0714	4.39	4.08	3.53	4.24	3.53	0.15	-0.16	-0.71	-0.71
mellitz_3bs_05_0714	3.13	3.35	2.96	3.19	2.43	-0.06	0.16	-0.23	-0.76
mellitz_3bs_06_0714	2.7	2.65	2.47	2.71	2.25	-0.01	-0.06	-0.24	-0.46
mellitz_3bs_07_0714	4.11	4.07	3.68	4.21	3.31	-0.1	-0.14	-0.53	-0.9
mellitz_3bs_08_0714	4.02	3.92	3.52	4.13	3.29	-0.11	-0.21	-0.61	-0.84
shanbhag_01_0914	4.93	4.98	4.61	5.08	4	-0.15	-0.1	-0.47	-1.08
Cavium_20dB_HghZ /w reduced xtlk	2.7	3.28	2.92	3.17	1.57	-0.47	0.11	-0.25	-1.6
Cavium_20dB_HghZ_Nom_HighZ /w reduced xtlk	2.96	3.46	3.11	3.36	1.94	-0.4	0.1	-0.25	-1.42